

PNE20080CPE-Q

200 V, 2 x 4 A dual common cathode hyperfast recovery rectifier

10 September 2021

Product data sheet

1. General description

High power density, hyperfast switching time dual recovery rectifier in common cathode configuration with high-efficiency planar technology, encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

Reverse voltage: V_R ≤ 200 V

Forward current: I_F ≤ 4 A (per diode)

Switching time: t_{rr} ≤ 30 ns

Pt doped life time control

Low inductance

Power and flat lead SMD plastic package

Package height typical 0.95 mm

High power capability due to clip-bond technology

· Planar die design

Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · General-purpose rectification
- Hyperfast switching
- Solenoid control
- Piezo injection
- Freewheeling applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode (u	unless otherwise specified)					
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 155 °C		-	-	4	Α
V _R	reverse voltage	T _j = 25 °C		-	-	200	V
V_{RRM}	repetitive peak reverse voltage			-	-	200	V
V _F	forward voltage	I _F = 4 A; T _j = 25 °C	[1]	-	860	930	mV
		I _F = 4 A; T _j = 125 °C	[1]	-	710	810	mV
I _R	reverse current	V _R = 200 V; T _j = 25 °C	[1]	-	-	1	μΑ
		V _R = 200 V; T _j = 125 °C	[1]	-	2	40	μA

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)		CC
2	A2	anode (diode 2)	1	
3	CC	common cathode	3 CFP15B (SOT1289B)	A1 A2 aaa-030081

6. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
PNE20080CPE-Q		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B				

7. Marking

Table 4. Marking codes

Type number	Marking code
PNE20080CPE-Q	200E
	008C

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134)

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode (u	nless otherwise specified)			-1		
V _R	reverse voltage	T _j = 25 °C		-	200	V
V_{RRM}	repetitive peak reverse voltage			-	200	V
$V_{R(RMS)lim}$	limiting RMS reverse voltage			-	140	V
l _F	forward current	δ = 1; T _{sp} ≤ 150 °C		-	5.6	Α
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 155 °C		-	4	А
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; single half sine wave (applied at rated load condition); $T_{j(init)}$ = 25 °C		-	90	А
		t_p = 8.3 ms; single half sine wave (applied at rated load condition); per device; $T_{j(init)}$ = 25 °C		-	170	A
Per device, o	one diode loaded					
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
T _j	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per device, on	e diode loaded					•	
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	90	K/W
			[2]	-	-	70	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[3]	-	-	7	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [3] Soldering point of cathode tab.

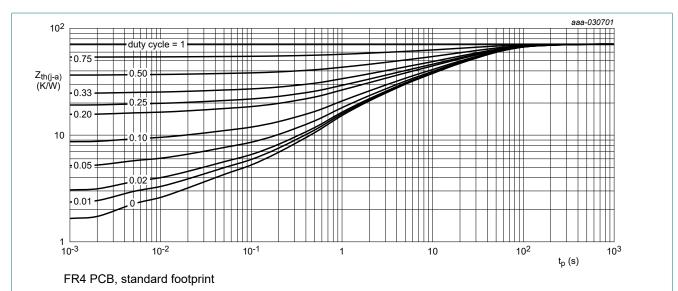
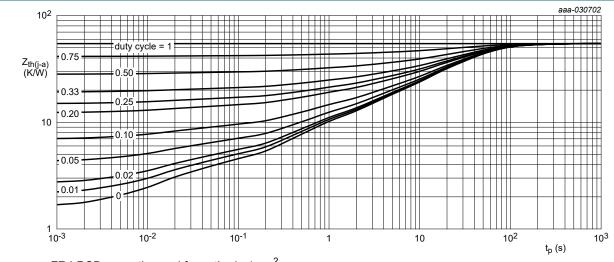


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

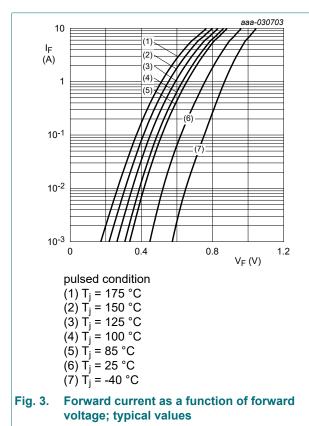
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode (unless otherwise specified)					
V _{(BR)R}	reverse breakdown voltage	I _R = 100 μA; T _j = 25 °C	[1]	200	-	-	V
V _F	forward voltage	I _F = 4 A; T _j = 25 °C	[1]	-	860	930	mV
		I _F = 4 A; T _j = 125 °C	[1]	-	710	810	mV
I _R	reverse current	V _R = 200 V; T _j = 25 °C	[1]	-	-	1	μΑ
		V _R = 200 V; T _j = 125 °C	[1]	-	2	40	μΑ
C _d	diode capacitance	V _R = 4 V; f = 1 MHz; T _j = 25 °C		-	60	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}$		-	12	30	ns
	reverse recovery time ramp recovery	$dI_F/dt = 50 \text{ A/}\mu\text{s}; I_F = 1 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 \text{ °C}$		-	19	-	ns
	reverse recovery time	$dI_F/dt = 100 A/\mu s; I_F = 1 A; V_R = 30 V;$		-	15	-	ns
I _{RM}	peak reverse recovery current	T _j = 25 °C		-	1	-	A
Q _{rr}	reverse recovery charge			-	9	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	785	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



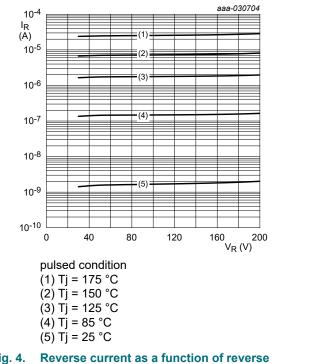


Fig. 4. Reverse current as a function of reverse voltage; typical values

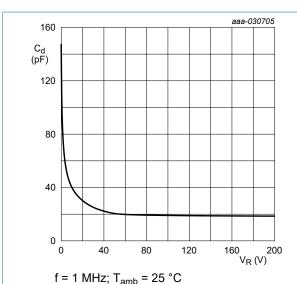
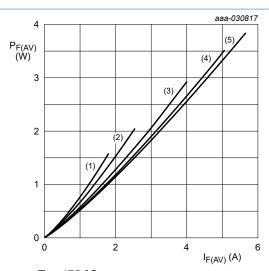
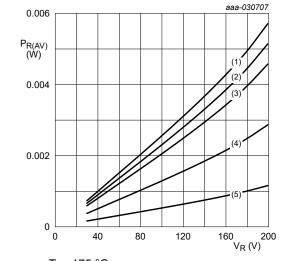


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



 $T_j = 175 \,^{\circ}\text{C}$ $(1) \, \delta = 0.1$ $(2) \, \delta = 0.2$ $(3) \, \delta = 0.5$ $(4) \, \delta = 0.8$ $(5) \, \delta = 1; \, DC$

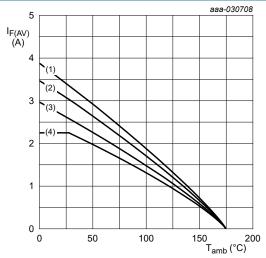
Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 175 \,^{\circ}\text{C}$ (1) $\delta = 1$; DC (2) $\delta = 0.9$ (3) $\delta = 0.8$ (4) $\delta = 0.5$

 $(5) \delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



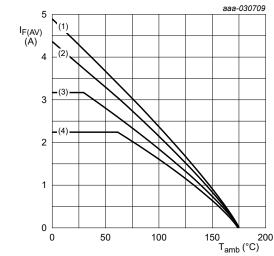
FR4 PCB, standard footprint

 $T_j = 175 \, ^{\circ}C$ (1) $\delta = 1$; DC (2) $\delta = 0.5$; $f = 20 \, kHz$

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

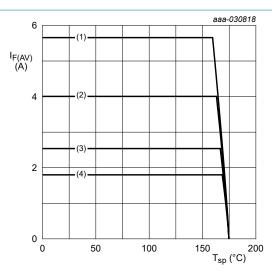
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$

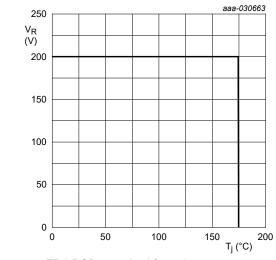
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

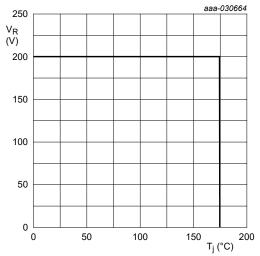
 $(4) \delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values



FR4 PCB, standard footprint $R_{th} = 90 \text{ K/W}$

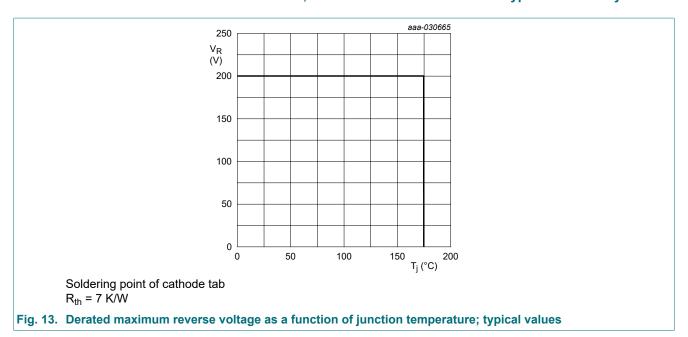
of junction temperature; typical values



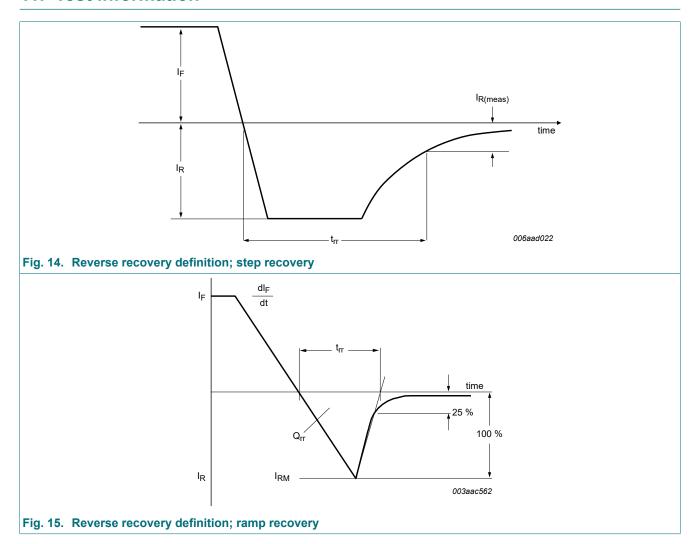
FR4 PCB, mounting pad for cathode 1 cm² $R_{th} = 70 \text{ K/W}$

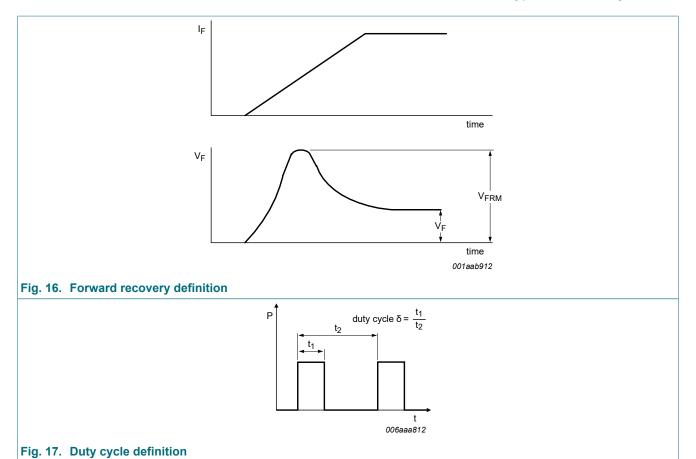
Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values

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11. Test information





The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

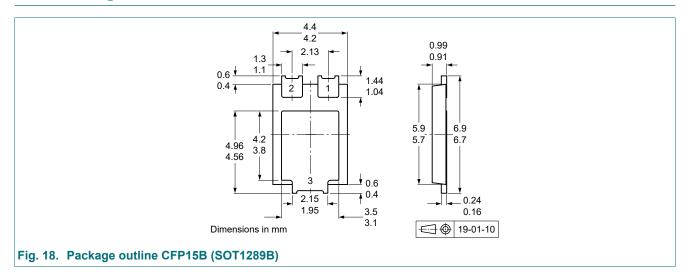
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$

with $I_{\mbox{\scriptsize RMS}}$ defined as RMS current.

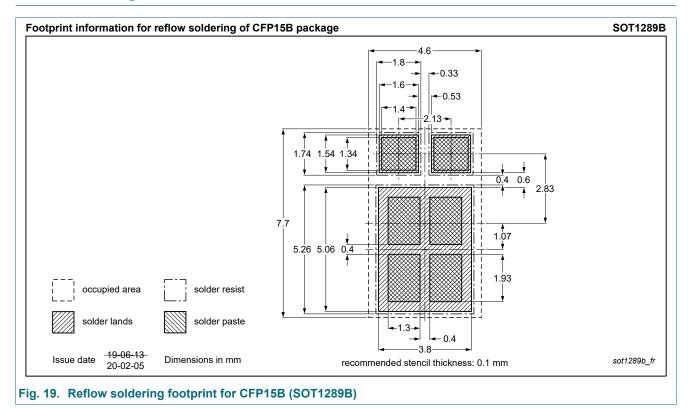
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PNE20080CPE-Q v.1	20210910	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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	Features and benefits

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